

MICRO-OPTICS

Axetris AG

#### INFRARED SOURCES Schwarzenbergstrasse 10

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MASS FLOW DEVICES

LASER GAS DETECTION

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# EMIRS50 AT06V BR26M

## Thermal MEMS based infrared source

For direct electrical fast modulation

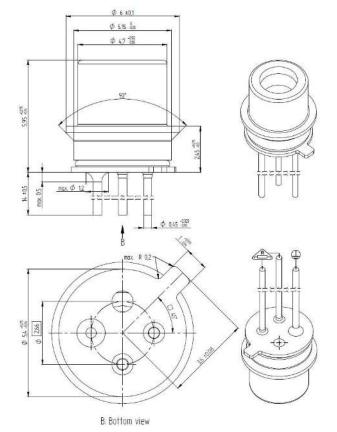
TO46 header with Reflector 7

#### ■ Infrared Source

Axetris infrared (IR) sources are micro-machined, electrically modulated thermal infrared emitters featuring true blackbody radiation characteristics, low power consumption, high emissivity and a long lifetime. The appropriate design is based on a resistive heating element deposited onto a thin dielectric membrane which is suspended on a micro-machined silicon structure.

#### Infrared Gas Detection Applications

- Measurement principles: non-dispersive infrared spectroscopy (NDIR), photoacoustic infrared spectroscopy (PAS) or attenuated-total-reflectance FTIR spectroscopy (ATR)
- Target gases: CO, CO<sub>2</sub>, VOC, NO<sub>x</sub>, NH<sub>3</sub>, SO<sub>x</sub>, SF<sub>6</sub>, hydrocarbons, humidity, anesthetic agents, refrigerants, breath alcohols
- Medical: Capnography, anesthesia gas monitoring, respiration monitoring, pulmonary diagnostics, blood gas analysis
- Industrial Applications: Combustible and toxic gas detection, refrigerant monitoring, flame detection, fruit ripening monitoring, SF<sub>6</sub> monitoring, semiconductor fabrication
- Automotive: CO<sub>2</sub> automotive refrigerant monitoring, alcohol detection & interlock, cabin air quality
- Environmental: Heating, ventilating and air conditioning (HVAC), indoor air quality and VOC monitoring, air quality monitoring



#### Features

- Large modulation depth at high frequencies
- Broad band emission
- Low power consumption
- Long lifetime
- True black body radiation (2 to 14 μm)
- Very fast electrical modulation (no chopper wheel needed)
- Suitable for portable and very small applications
- Rugged MEMS design



#### ■ Absolute Maximum Ratings (T<sub>A</sub> = 22°C)

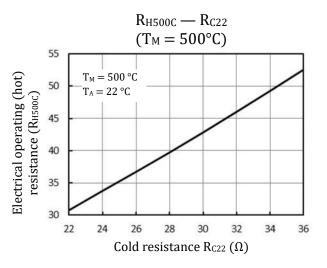
Parameter	Symbol	Rating	Unit
Heater membrane temperature <sup>1</sup>	Тм	500	°C
Optical output power (hemispherical spectral) ( $T_M = 500^{\circ}$ C)	Poo	4.1	mW
Optical output power between 4 $\mu$ m and 5 $\mu$ m (T <sub>M</sub> = 500°C)	P <sub>s4-5</sub>	0.59	mW
Optical output power between 6 $\mu$ m and 8 $\mu$ m (T <sub>M</sub> = 500°C)	P <sub>s6-8</sub>	0.77	mW
Optical output power between 8 $\mu$ m and 10 $\mu$ m (T <sub>M</sub> = 500°C)	P <sub>s8-10</sub>	0.47	mW
Optical output power between 10 $\mu$ m and 13 $\mu$ m (T <sub>M</sub> = 500°C)	P <sub>s10-13</sub>	0.39	mW
Electrical cold resistance (at $T_M = T_A = 22$ °C)	R <sub>C22</sub>	22 to 36	Ω
Electrical operating (hot) resistance <sup>2</sup> (at $T_M = 500$ °C with $f = \ge 10$ Hz and $t_{on} \ge 3$ ms)	R <sub>H500C</sub>	1.555 * RC22 - 3.618	Ω
Package temperature	TP	80	°C
Storage temperature	Ts	-20 to +85	°C
Ambient temperature <sup>3</sup> (operation)	T <sub>A</sub>	-40 to +125	°C
Heater area	A <sub>H</sub>	0.8 x 0.8	mm <sup>2</sup>
Frequency <sup>4</sup>	f	10 to 100	Hz

Note: Emission power in this table is defined by hemispherical radiation. Stress beyond those listed under "absolute maximum ratings" may cause permanent damage to the device.

Note: Diagram RH500C — RC22 |  $(T_M = 500^{\circ}C)$ 

How to ensure that the maximum temperature for  $T_{\mbox{\scriptsize M}}$  is not exceeded:

- 1. Determine electrical cold resistance  $R_c$  of the EMIRS device at TA=22°C
- - a.  $f \ge 10 \text{ Hz}$
  - b. on-time (pulse duration)  $\ge$  3 ms



Electrical operating (hot) resistance  $R_H$  versus electrical cold resistance  $R_{C22}$  at  $T_A = 22^{\circ}C$ 

<sup>&</sup>lt;sup>1</sup> Temperatures above 500°C will impact drift and lifetime of the devices.

<sup>&</sup>lt;sup>2</sup> See Diagram  $R_H - R_C | (T_M = 500^{\circ}C)$ 

<sup>&</sup>lt;sup>3</sup> The environmental and package temperature might impact the lifetime and characteristic of the devices.

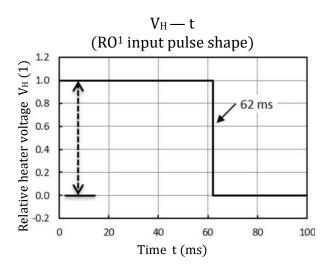
<sup>&</sup>lt;sup>4</sup> Lower cut-off frequency of 10 Hz for designed thermodynamic state. DC drive is also possible but recommended with "soft-off" switch.



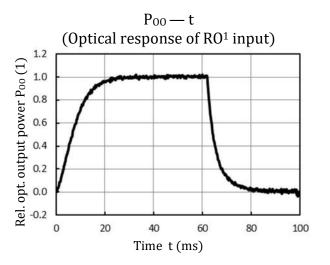
### Ratings at Reference Operation (RO<sup>1</sup> T<sub>A</sub> = 22°C)

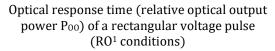
Parameter	Symbol	Rating	Unit
Heater membrane temperature	Тм	< 500	°C
Duty cycle of rectangular $V_H$ pulse	D	62	%
Frequency of rect. pulse shape <sup>2</sup>	$\mathbf{f}_{ref}$	10	Hz
On time constant of integral emissive power $P_{00}$	$ au_{on}$	10	ms
Off time constant of integral emissive power $P_{00}$	$ au_{\mathrm{off}}$	5	ms
Package temperature at $T_A = 22^{\circ}C$	Тр	40 to 50	°C

Note: First order on-time model using  $\tau_{on}$ : First order off-time model using  $\tau_{off}$ :



 $\label{eq:Relative rectangular heater voltage (V_{H}) \mbox{ pulse with a relative pulse width of 62 ms at 10 Hz} (time description of reference operation RO^1)$ 



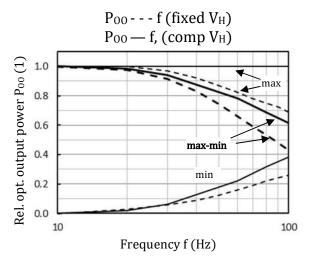


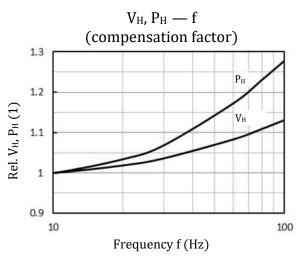
<sup>&</sup>lt;sup>1</sup> Reference Operation: combines lower cut-off frequency of 10 Hz and maximum modulation depth (max-min signal)

 $<sup>^{\</sup>rm 2}$  Recommended frequencies from 10 Hz to 100 Hz



#### ■ Typical Timing Characteristics Frequency (D = 62%)





 $\begin{array}{l} \mbox{Relative (to RO) max, min, max-min values of optical} \\ \mbox{output power (P_{00}) versus frequency f with fixed and} \\ \mbox{compensated } V_{\rm H} \end{array}$ 

Note: Diagrams a, b <u>Relative</u>  $P_{00}$ , V<sub>H</sub>, P<sub>H</sub> to reference operation (RO) f=10 Hz, rect. pulse D=62%

<u>max</u>: maximum value of  $P_{00}$  response shape <u>min</u>: minimum value of  $P_{00}$  response shape <u>max-min</u>: amplitude calculation of  $P_{00}$  resp. shape

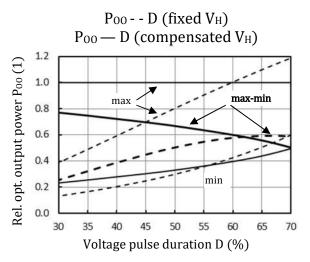
Fixed V<sub>H</sub>: same voltage for all frequencies.

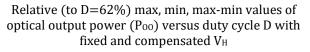
<u>Compensated</u>  $V_{\text{H}}$ : for every frequency value, the voltage is adjusted to achieve the same maximum of  $P_{00}$  response shape as for 10 Hz.

Relative (to RO) electrical drive values heater voltage  $V_{\rm H}$  and power  $P_{\rm H}$  versus frequency f for compensation



#### ■ Typical Timing Characteristics Pulse Duration D<sup>1</sup> (f = 100 Hz)



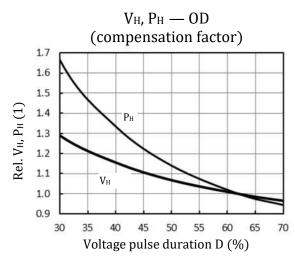


Note: Diagrams a, b <u>Relative</u>  $P_{00}$ , V<sub>H</sub>, P<sub>H</sub> to reference operation (RO) f=100 Hz, rect. voltage pulse

<u>max</u>: maximum value of  $P_{00}$  response shape <u>min</u>: minimum value of  $P_{00}$  response shape <u>max-min</u>: amplitude calculation of  $P_{00}$  resp. shape

Fixed V<sub>H</sub>: same voltage for all frequencies.

<u>Compensated</u>  $V_{H}$ : for every frequency value, the voltage is adjusted to achieve the same maximum of  $P_{00}$  response shape as for D=62%.



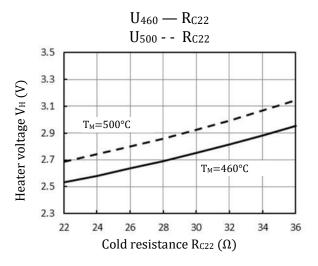
Relative (to RO) electrical drive values heater voltage  $V_H$  and power  $P_H$  versus duty cycle D for compensation

<sup>&</sup>lt;sup>1</sup> Effective D shorter than 30% and voltage or power compensation at high frequencies (e.g. 20% @ 100 Hz) might impact the lifetime and characteristic of the devices because of additional stress in material layers.



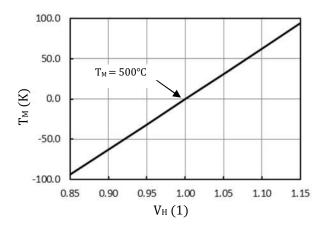
#### ■ Typical electrical/thermal characteristics (RO, T<sub>A</sub> = 22°C)

Parameter	Symbol	Rating	Unit
Peak chip membrane temperature	Тм	460	°C
Heater voltage	V <sub>H</sub>	2.69	V
Heater power	P <sub>H</sub>	187	mW

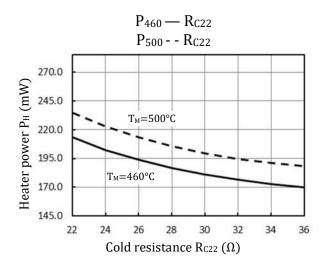


 $\label{eq:Mean1} Mean^1 \mbox{ and upper bound of heater voltage } V_{\rm H} \mbox{ vs. cold} \\ resistance \mbox{ RC}_{22}$ 



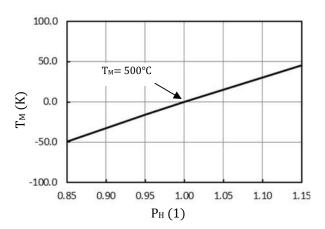


Relative change of membrane temperature  $(T_M)$  by changing heater voltage  $(V_H)$ 



 $\label{eq:mean1} Mean^1 \mbox{ and upper bound of heater power } P_H \mbox{ vs. cold} \\ resistance \mbox{ RC}_{22}$ 



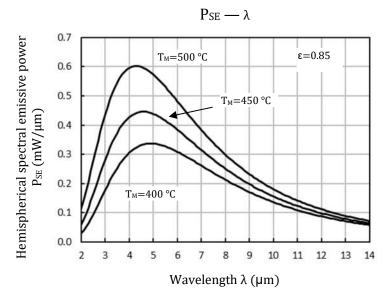


Relative change membrane temperature ( $T_M$ ) by changing heater power ( $P_H$ )

 $<sup>^1</sup>$  Recommended operation mode  $T_{\rm M}$  =460°C, which ensures 95% confidence that the maximum temperature  $T_{\rm M}$  = 500°C is not exceeded.

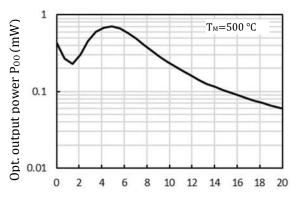


■ Typical Optical Characteristics (RO, T<sub>A</sub> = 22°C)

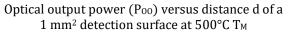


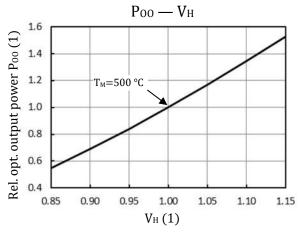
Hemispherical spectral emissive power of EMIRS50 chip surface with a typical emissivity (mean from 2 to 14  $\mu m)$  of  $\epsilon{=}0.85$ 

 $P_{00} - d$ 



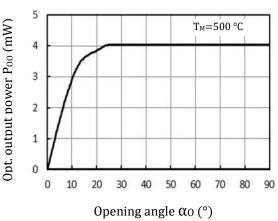
Distance d between EMIRS50 and detector (mm)



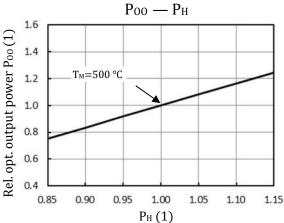


Relative change of optical output power ( $P_{00}$ ) by changing heater voltage ( $V_H$ )

 $P_{00} - \alpha_0$ 



Optical output power (P\_{00}) versus opening angle  $\alpha_0$  (integral rotation of a cone) at 500°C  $T_{\rm M}$ 



Relative change of optical output power  $(P_{00})$  by changing heater power  $(P_H)$ 



#### ■ Specified Ratings at Test Voltage $V_T$ (on-time $\ge 20$ ms, $T_H = T_A = 22^{\circ}C$ )

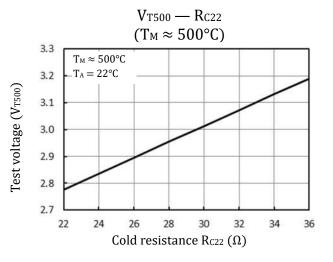
Parameter	Symbol	Condition	Typical value	Unit
Test voltage (for $T_M \approx 500^{\circ}$ C)	VT	$T_H = T_A = 20^\circ C$	0.0295 * RC22 + 2.1271	V
Optical output power (after 20 ms on)	P <sub>00</sub>	after $\ge 20 \text{ ms } V_T$ on time, $T_P = T_A = 22^{\circ}C$	4.50	mW

Note: Other optical output specifications are possible by customer specific requirements (e.g. spectral ranges).

Note: Diagram  $V_{T500C}$  —  $R_{C22}$  | ( $T_M \approx 500^{\circ}$ C)

Defined test voltage  $V_T$  for specified ratings:

- 1. Determine electrical cold resistance  $R_{C22}$  of the EMIRS device at  $T_A=22$ °C
- 2. Drive the device with  $V_{\rm T}$  for each  $R_{\rm C}$  as shown in this diagram.
- 3. Ratings are only valid for  $T_P = T_A = 22^{\circ}C$  and after 20 ms on-time.



Test voltage  $V_T$  versus electrical cold resistance  $R_{C22}$  at  $T_A = 22^\circ C$